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Thank you for your cooperation and understanding,

WeEn Semiconductors





# **BYQ28 series E and ED**

# Rectifier diodes ultrafast, rugged

Rev. 05 — 26 October 2016

**Product data sheet** 

## 1. Product profile

## 1.1 General description

Ultrafast, dual common cathode, epitaxial rectifier diodes in a SOT78 (TO-220AB) and a SOT428 (DPAK) plastic package.

### 1.2 Features

- Fast switching
- Soft recovery characteristic
- Reverse surge capability
- Low thermal resistance
- Low forward voltage drop
- High thermal cycling performance

## 1.3 Applications

Output rectifiers in high-frequency switched-mode power supplies

### 1.4 Quick reference data

- $V_{RRM} \le 200 \text{ V}$
- $V_F \le 0.895 \text{ V}$

- $I_{O(AV)} \le 10 A$
- $t_{rr} = 10 \text{ ns (typ)}$

# 2. Pinning information

### Table 1. Pinning

Pin	Description	Simplified outline	(	Symbol
1	anode 1			
2	cathode	[1] mb	mb	1
3	anode 2	705		2
mb	mounting base; cathode		1 3 SOT428 (DPAK)	2 sym084
		SOT78 (3-lead TO-220AB)		

<sup>[1]</sup> It is not possible to connect to pin 2 of the SOT428 package.

# **Ordering information**

#### Table 2. **Ordering information**

Type number	Package					
	Name	Description	Version			
BYQ28E-200	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78			
BYQ28ED-200	DPAK	plastic single-ended surface-mounted package (DPAK); 3-leads (one lead cropped)	SOT428			

# **Limiting values**

#### Table 3. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

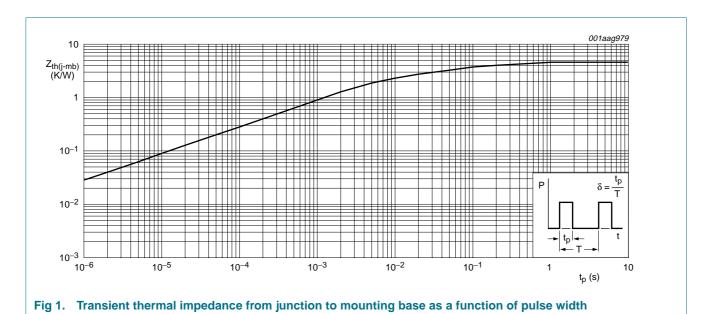
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage		-	200	V
$V_{RWM}$	crest working reverse voltage		-	200	V
$V_R$	reverse voltage	square waveform; $\delta = 1.0$	-	200	V
I <sub>O(AV)</sub>	average output current	square waveform; $\delta$ = 0.5; $T_{mb} \le 119$ °C; both diodes conducting	-	10	Α
I <sub>FRM</sub>	repetitive peak forward current	$t_p$ = 25 $\mu$ s; square waveform; $\delta$ = 0.5; $T_{mb} \le$ 119 °C; per diode	-	10	Α
I <sub>FSM</sub>	non-repetitive peak forward current	t = 10 ms; sinusoidal waveform; per diode	-	50	Α
		t = 8.3 ms; sinusoidal waveform; per diode	-	55	Α
I <sub>RM</sub>	peak reverse recovery current	$t_p = 2 \mu s; \delta = 0.001$	-	0.2	Α
I <sub>RSM</sub>	non-repetitive peak reverse current	t <sub>p</sub> = 100 μs	-	0.2	Α
T <sub>stg</sub>	storage temperature		-40	+150	°C
Tj	junction temperature		-	150	°C
Electrosta	atic discharge				
V <sub>ESD</sub>	electrostatic discharge voltage	all pins; human body model; C = 250 pF; R = 1.5 k $\Omega$	-	8	kV

## 5. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	with heatsink compound; per diode; see Figure 1	-	-	4.5	K/W
		with heatsink compound; both diodes conducting	-	-	3	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air; SOT78	-	60	-	K/W
		SOT428	[1] -	50	-	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

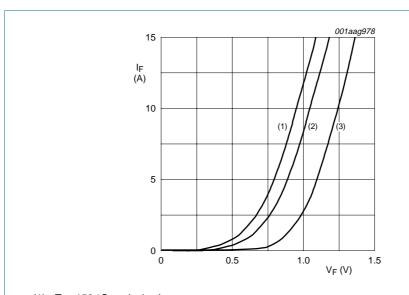


## **Characteristics**

Table 5. **Characteristics** 

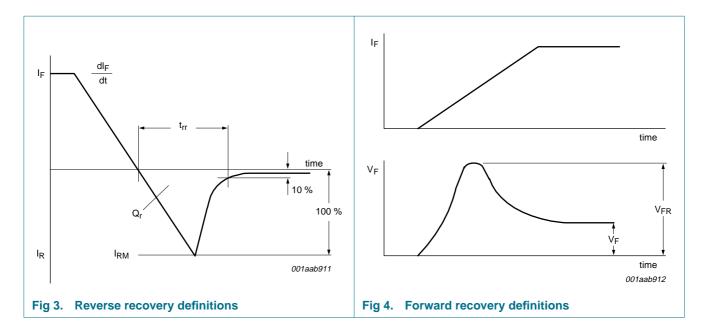
 $T_i = 25 \,^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V <sub>F</sub>	forward voltage	$I_F = 5 \text{ A}$ ; $T_j = 150 ^{\circ}\text{C}$ ; see Figure 2	-	0.8	0.895	V
		I <sub>F</sub> = 5 A; see <u>Figure 2</u>	-	0.95	1.1	V
		I <sub>F</sub> = 10 A; see <u>Figure 2</u>	-	1.1	1.25	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 200 V	-	2	10	μΑ
		$V_R = 200 \text{ V}; T_j = 100 ^{\circ}\text{C}$	-	0.1	0.2	mΑ
Dynamic o	characteristics					
Q <sub>r</sub>	recovered charge	$I_F$ = 2 A to $V_R$ $\geq$ 30 V; $dI_F/dt$ = 20 A/ $\mu$ s; see Figure 3	-	4	9	nC
t <sub>rr</sub>	reverse recovery time	ramp recovery; $I_F = 1$ A to $V_R \ge 30$ V; $dI_F/dt = 100$ A/ $\mu$ s; see Figure 3	-	15	25	ns
		step recovery; when switched from $I_F = 0.5 \text{ A to } I_R = 1 \text{ A}$ ; measured at $I_R = 0.25 \text{ A}$	-	10	20	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F$ = 5 A to $V_R$ $\geq$ 30 V; $dI_F/dt$ = 50 A/ $\mu$ s; see Figure 3	-	0.5	0.7	Α
$V_{FR}$	forward recovery voltage	$I_F = 1 \text{ A}$ ; $dI_F/dt = 10 \text{ A/}\mu\text{s}$ ; see Figure 4	-	1	-	V



- (1)  $T_j = 150 \,^{\circ}\text{C}$ ; typical values
- (2)  $T_j = 150 \,^{\circ}C$ ; maximum values
- (3)  $T_j = 25$  °C; maximum values

Fig 2. Forward current as a function of forward voltage



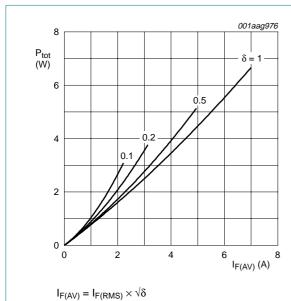
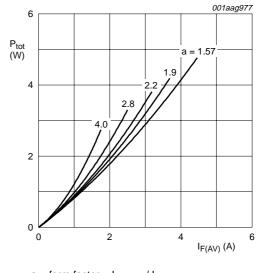


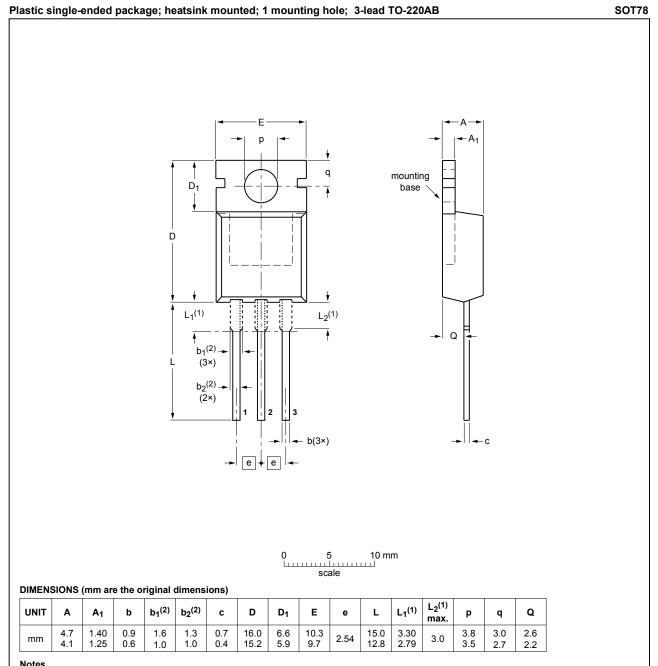
Fig 5. Forward power dissipation as a function of average forward current; square waveform; maximum values



 $a = form factor = I_{F(RMS)} / I_{F(AV)}$ 

Fig 6. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

## 7. Package outline

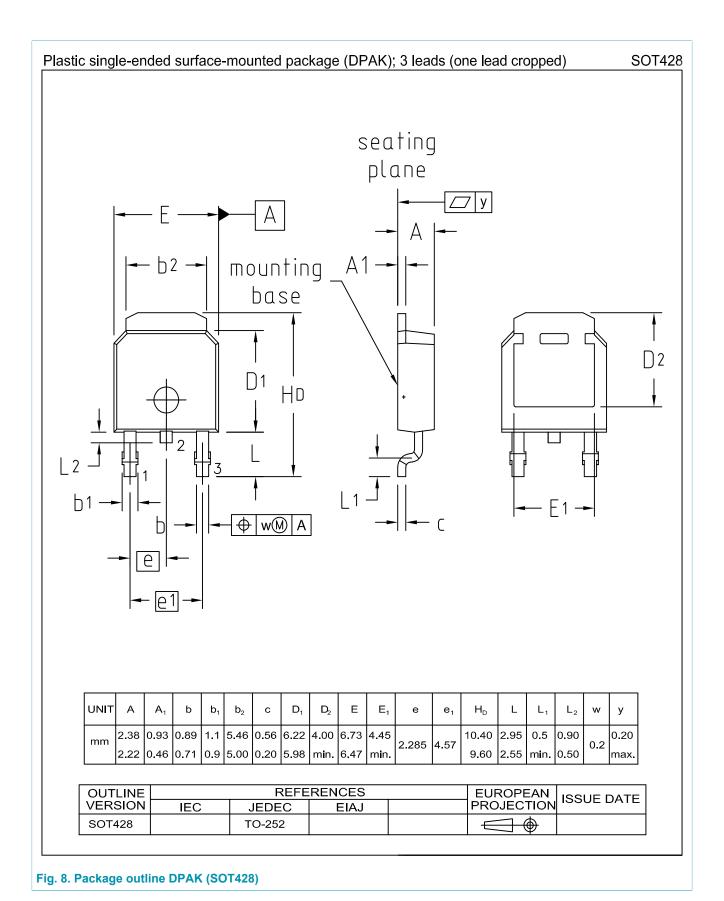


- 1. Lead shoulder designs may vary.
- 2. Dimension includes excess dambar.

OUTLINE		REFER	REFERENCES		EUROPEAN	
VERSION	IEC	JEDEC	JEITA	PROJECTION		ISSUE DATE
SOT78		3-lead TO-220AB	SC-46			<del>08-04-23</del> 08-06-13

Fig 7. Package outline SOT78 (TO-220AB)

BYQ28\_SER\_E\_ED\_4



# **Revision history**

#### Table 6. **Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
BYQ28_SER_E_ED_4	20071205	Product data sheet	-	BYQ28E_SERIES_3
Modifications:  • The format of this data sheet has been redesigned to comply with the new guidelines of NXP Semiconductors.				nply with the new identity
	<ul> <li>Legal texts</li> </ul>	s have been adapted to the	e new company name	e where appropriate.
	-	alues table: some paramet ; I <sub>FRM</sub> conditions amended		ded to conform to latest
		istics: Q <sub>rr</sub> changed to Q <sub>r</sub> 're overy' and 'step recovery' a	•	and $t_{rr2}$ changed to $t_{rr}$ with
BYQ28E_SERIES_3	19981001	Product specification	-	BYQ28E_SERIES_2
BYQ28E_SERIES_2	19980701	Product specification	-	BYQ28E_SERIES_1; BYQ28EB_SERIES_1
BYQ28E_SERIES_1; BYQ28EB_SERIES_1	19960801	Product specification	-	-

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# 9. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term short data sheet is explained in section "Definitions".
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## **WeEn Semiconductors**

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Rectifier diodes ultrafast, rugged

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